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Slater, Jr. et al.

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(54) **LIGHT EMITTING DIODES INCLUDING MODIFICATIONS FOR LIGHT EXTRACTION**

(75) Inventors: **David B. Slater, Jr.**, Raleigh, NC (US); **Robert C. Glass**, Chapel Hill, NC (US); **Charles M. Swoboda**, Morrisville, NC (US); **Bernd Keller**, Goleta, CA (US); **James Ibbetson**, Goleta, CA (US); **Brian Thibeault**, Santa Barbara, CA (US); **Eric J. Tarsa**, Goleta, CA (US)

(73) Assignee: **Cree, Inc.**, Durham, NC (US)

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Related U.S. Application Data

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(51) **Int. Cl.**[7] **H01L 33/00**
(52) **U.S. Cl.** **257/99**; 257/95; 257/98
(58) **Field of Search** 257/95, 98, 99

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Primary Examiner—Jerome Jackson
(74) *Attorney, Agent, or Firm*—Myers Bigel Sibley & Sajovec

(57) **ABSTRACT**

Light emitting diodes include a substrate having first and second opposing faces and that is transparent to optical radiation in a predetermined wavelength range and that is patterned to define, in cross-section, a plurality of pedestals that extend into the substrate from the first face towards the second face. A diode region on the second face is configured to emit light in the predetermined wavelength range, into the substrate upon application of voltage across the diode region. A mounting support on the diode region, opposite the substrate is configured to support the diode region, such that the light that is emitted from the diode region into the substrate, is emitted from the first face upon application of voltage across the diode region. The first face of the substrate may include therein a plurality of grooves that define the plurality of triangular pedestals in the substrate. The grooves may include tapered sidewalls and/or a beveled floor. The first face of the substrate also may include therein an array of via holes. The via holes may include tapered sidewalls and/or a floor.

104 Claims, 15 Drawing Sheets

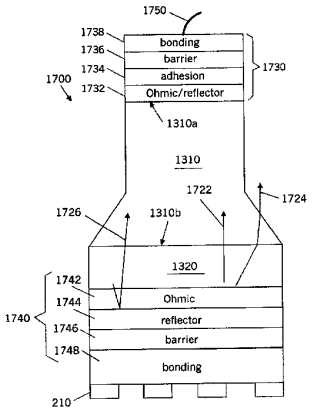

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FIG. 1

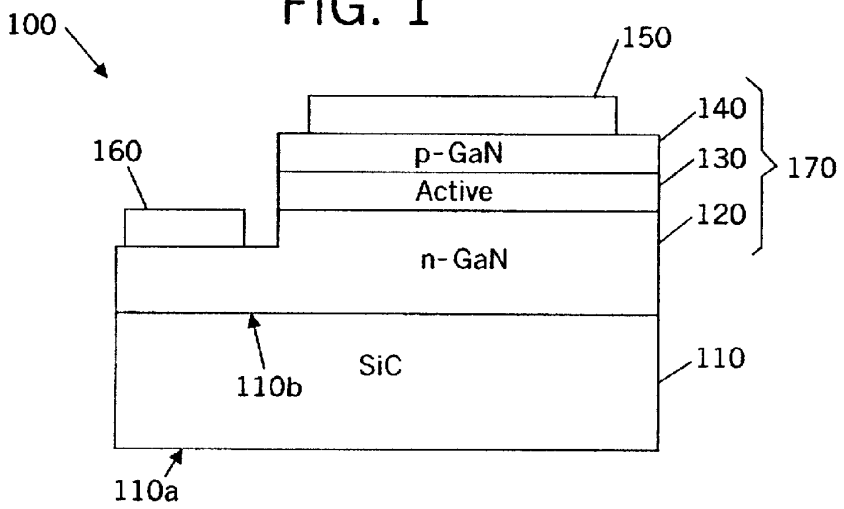


FIG. 2

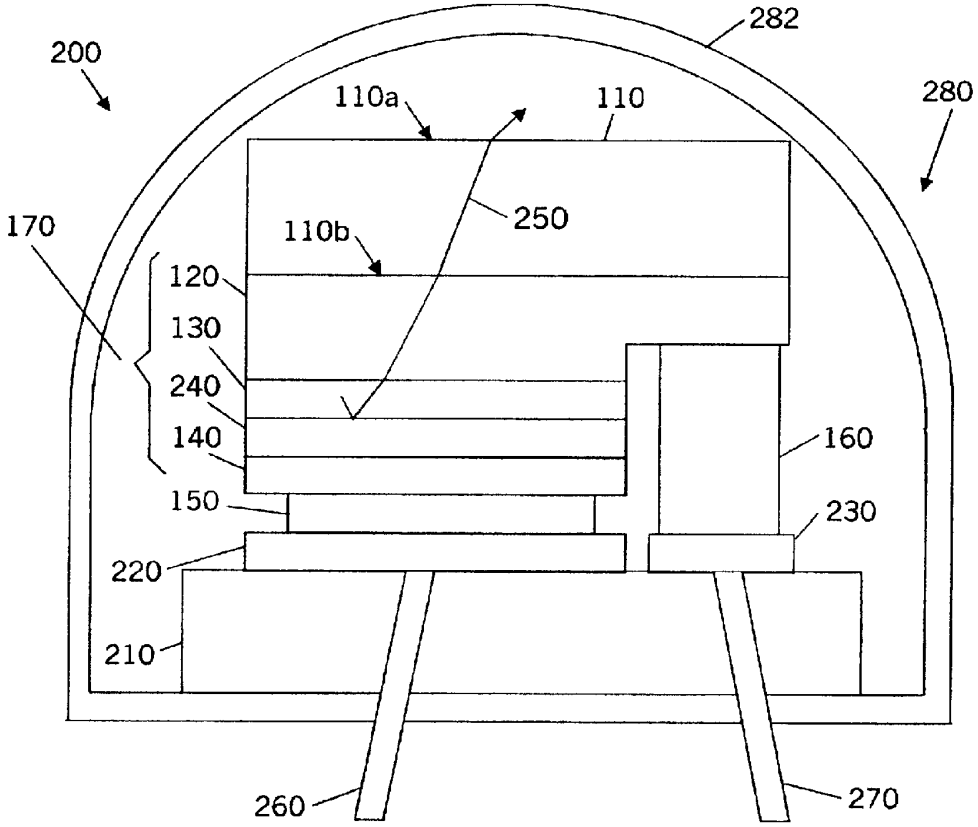


FIG. 3

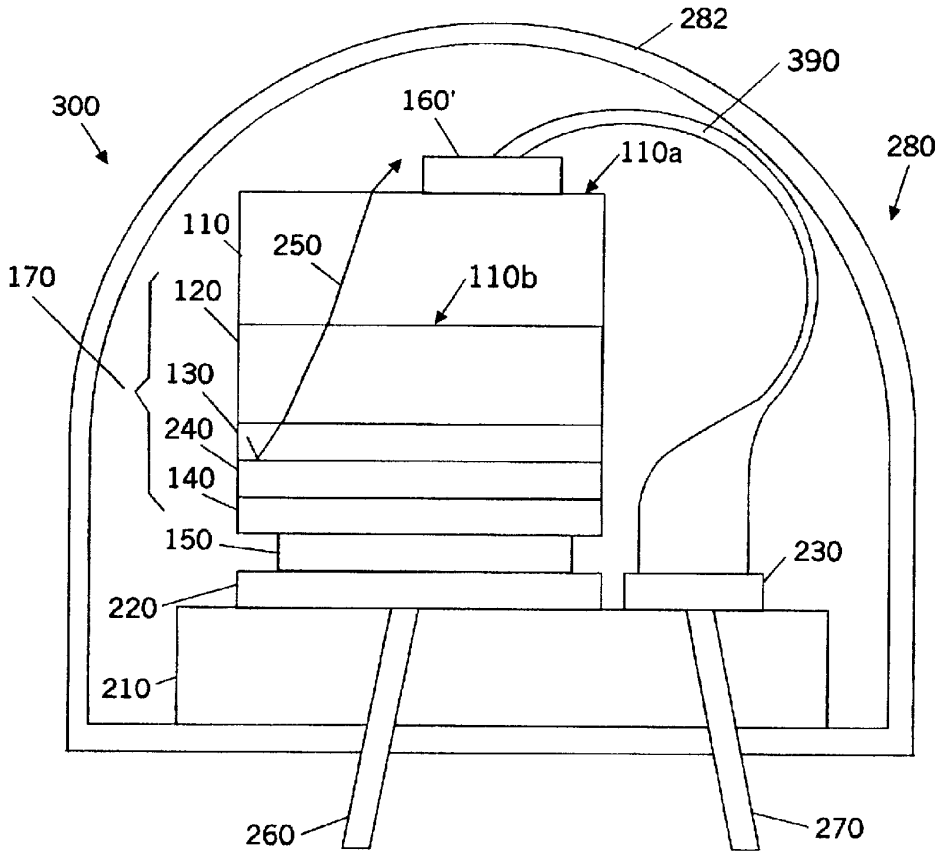


FIG. 13

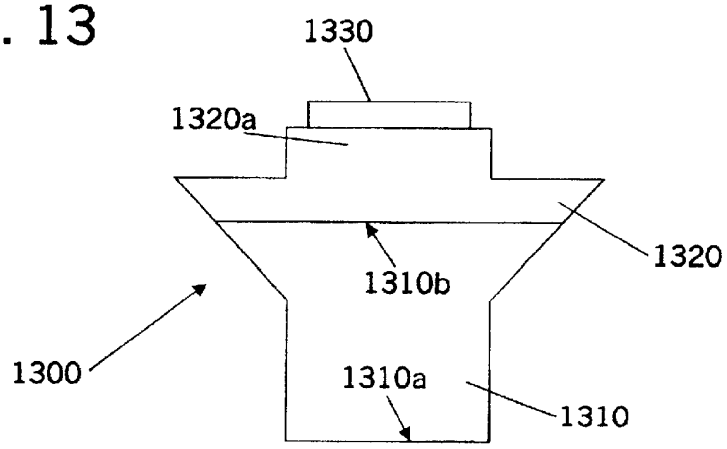


FIG. 4

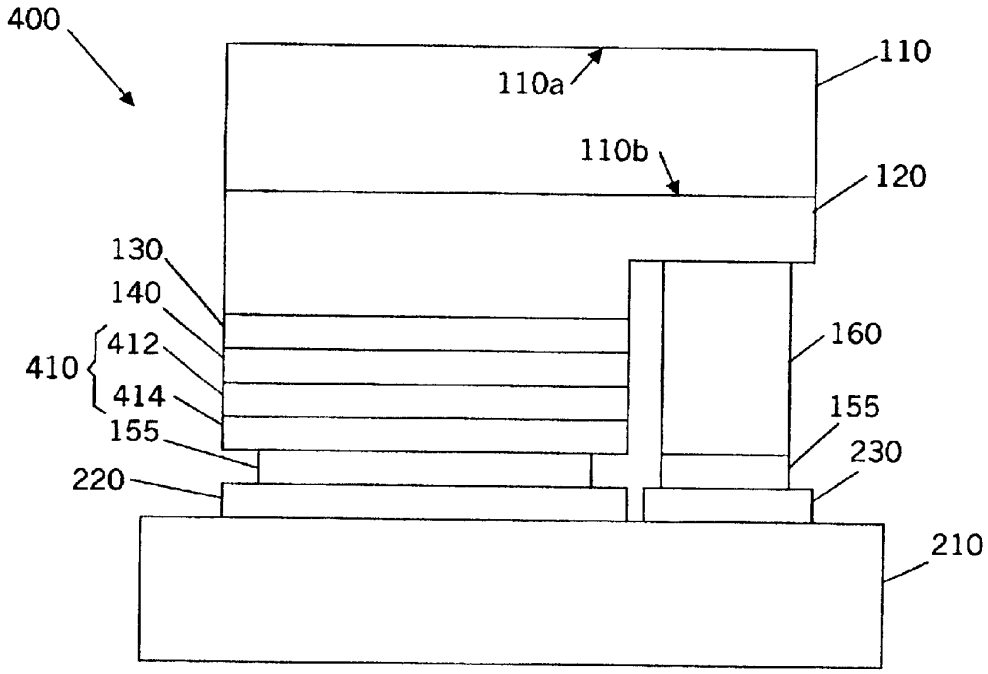
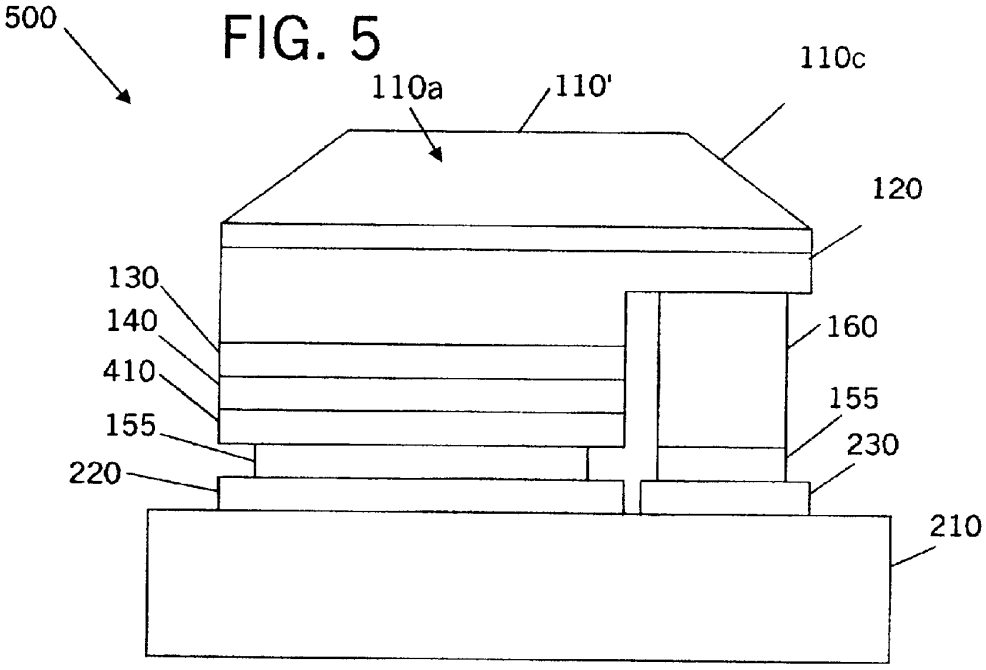


FIG. 5



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